

### Features

- Low power consumption: 235  $\mu\text{A}$  typ. at 5 V
- Supply voltage: 3 V to 16 V
- Gain bandwidth product: 900 kHz typ.
- Low offset voltage
  - “A” version: 600  $\mu\text{V}$  max.
  - Standard version: 1 mV max.
- Low input bias current: 1 pA typ.
- High tolerance to ESD: 4 kV
- Wide temperature range: -40 to +125 °C
- Automotive qualification
- Tiny packages available
  - SOT23-5
  - DFN8 2 mm x 2 mm, MiniSO8, SO8
  - QFN16 3 mm x 3 mm, TSSOP14

### Benefits

- Power savings in power-conscious applications
- Easy interfacing with high impedance sensors

### Related products

- See TSX63x series for reduced power consumption (45  $\mu\text{A}$ , 200 kHz)
- See TSX92x series for higher gain bandwidth products (10 MHz)

### Applications

- Industrial and automotive signal conditioning
- Active filtering
- Medical instrumentation
- High impedance sensors

### Description

The TSX56x, TSX56xA series of operational amplifiers benefit from STMicroelectronics® 16 V CMOS technology to offer state-of-the-art accuracy and performance in the smallest industrial packages. The TSX56x, TSX56xA have pinouts compatible with industrial standards and offer an outstanding speed/power consumption ratio, 900 kHz gain bandwidth product while consuming only 250  $\mu\text{A}$  at 16 V. Such features make the TSX56x, TSX56xA ideal for sensor interfaces and industrial signal conditioning. The wide temperature range and high ESD tolerance ease use in harsh automotive applications.

**Table 1. Device summary**

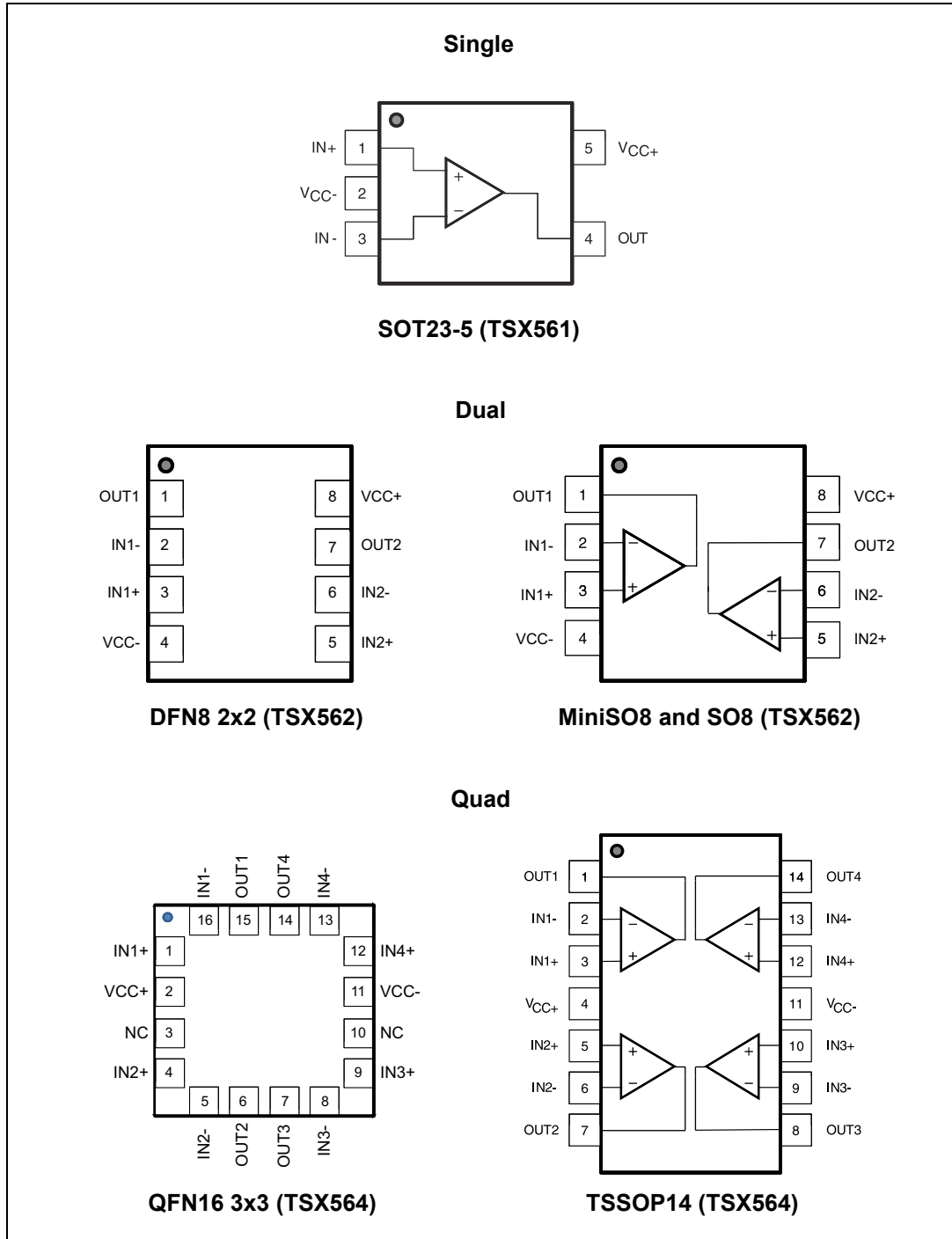
| Version | Standard $V_{io}$ | Enhanced $V_{io}$ |
|---------|-------------------|-------------------|
| Single  | TSX561            | TSX561A           |
| Dual    | TSX562            | TSX562A           |
| Quad    | TSX564            | TSX564A           |

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# 1 Pin connections

Figure 1. Pin connections for each package (top view)



## 2 Absolute maximum ratings and operating conditions

**Table 2. Absolute maximum ratings (AMR)**

| Symbol     | Parameter  | Value                              | Unit |
|------------|--|------------------------------------|------|
| $V_{CC}$   | Supply voltage <sup>(1)</sup>                            | 18                                 | V    |
| $V_{id}$   | Differential input voltage <sup>(2)</sup>                | $\pm V_{CC}$                       |      |
| $V_{in}$   | Input voltage <sup>(3)</sup>                             | $V_{CC-} - 0.2$ to $V_{CC+} + 0.2$ |      |
| $I_{in}$   | Input current <sup>(4)</sup>                             | 10                                 | mA   |
| $T_{stg}$  | Storage temperature                                      | -65 to +150                        | °C   |
| $R_{thja}$ | Thermal resistance junction to ambient <sup>(5)(6)</sup> |                                    | °C/W |
|            | SOT23-5  | 250                                |      |
|            | DFN8 2x2   | 120                                |      |
|            | MiniSO8  | 190                                |      |
|            | SO8  | 125                                |      |
|            | QFN16 3x3<br>TSSOP14                                     | 80<br>100                          |      |
| $R_{thjc}$ | Thermal resistance junction to case                      |                                    | °C/W |
|            | DFN8 2x2   | 33                                 |      |
|            | QFN16 3x3  | 30                                 |      |
| $T_j$      | Maximum junction temperature                             | 150                                | °C   |
| ESD        | HBM: human body model <sup>(7)</sup>                     | 4                                  | kV   |
|            | MM: machine model for TSX561 <sup>(8)</sup>              | 200                                | V    |
|            | MM: machine model for TSX562 and TSX564 <sup>(8)</sup>   | 100                                |      |
|            | CDM: charged device model <sup>(9)</sup>                 | 1.5                                | kV   |
|            | Latch-up immunity  | 200                                | mA   |

1. All voltage values, except differential voltage, are with respect to network ground terminal.
2. The differential voltage is the non-inverting input terminal with respect to the inverting input terminal.
3.  $V_{CC} - V_{in}$  must not exceed 18 V,  $V_{in}$  must not exceed 18 V.
4. Input current must be limited by a resistor in series with the inputs.
5. Short-circuits can cause excessive heating and destructive dissipation.
6.  $R_{th}$  are typical values.
7. Human body model: 100 pF discharged through a 1.5 kΩ resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
8. Machine model: a 200 pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω), done for all couples of pin combinations with other pins floating.
9. Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to ground.

**Table 3. Operating conditions**

| Symbol     | Parameter                            | Value                              | Unit |
|------------|--------------------------------------|------------------------------------|------|
| $V_{CC}$   | Supply voltage                       | 3 to 16                            | V    |
| $V_{icm}$  | Common mode input voltage range      | $V_{CC-} - 0.1$ to $V_{CC+} + 0.1$ |      |
| $T_{oper}$ | Operating free air temperature range | -40 to +125                        | °C   |

### 3 Electrical characteristics

Table 4. Electrical characteristics at  $V_{CC+} = +3.3\text{ V}$  with  $V_{CC-} = 0\text{ V}$ ,  $V_{icm} = V_{CC}/2$ ,  $T_{amb} = 25\text{ °C}$ , and  $R_L = 10\text{ k}\Omega$  connected to  $V_{CC}/2$  (unless otherwise specified)

| Symbol                   | Parameter  | Conditions                                   | Min. | Typ. | Max.               | Unit                    |
|--------------------------|--|--|------|------|--------------------|-------------------------|
| <b>DC performance</b>    |  |  |      |      |                    |                         |
| $V_{io}$                 | Offset voltage   | TSX56xA, $T = 25\text{ °C}$                  |      |      | 600                | $\mu\text{V}$           |
|                          |  | TSX56xA, $-40\text{ °C} < T < 125\text{ °C}$ |      |      | 1800               |                         |
|                          |  | TSX56x, $T = 25\text{ °C}$                   |      |      | 1                  | mV                      |
|                          |  | TSX56x, $-40\text{ °C} < T < 125\text{ °C}$  |      |      | 2.2                |                         |
| $\Delta V_{io}/\Delta T$ | Input offset voltage drift   | $-40\text{ °C} < T < 125\text{ °C}^{(1)}$    |      | 2    | 12                 | $\mu\text{V}/\text{°C}$ |
| $I_{io}$                 | Input offset current<br>( $V_{out} = V_{CC}/2$ )   | $T = 25\text{ °C}$                           |      | 1    | 100 <sup>(2)</sup> | pA                      |
|                          |  | $-40\text{ °C} < T < 125\text{ °C}$          |      | 1    | 200 <sup>(2)</sup> |                         |
| $I_{ib}$                 | Input bias current<br>( $V_{out} = V_{CC}/2$ )   | $T = 25\text{ °C}$                           |      | 1    | 100 <sup>(2)</sup> |                         |
|                          |  | $-40\text{ °C} < T < 125\text{ °C}$          |      | 1    | 200 <sup>(2)</sup> |                         |
| CMR1                     | Common mode rejection ratio<br>$CMR = 20 \log (\Delta V_{ic}/\Delta V_{io})$<br>( $V_{ic} = -0.1\text{ V}$ to $V_{CC}-1.5\text{ V}$ ,<br>$V_{out} = V_{CC}/2$ , $R_L > 1\text{ M}\Omega$ ) | $T = 25\text{ °C}$                           | 63   | 80   |                    | dB                      |
|                          |  | $-40\text{ °C} < T < 125\text{ °C}$          | 59   |      |                    |                         |
| CMR2                     | Common mode rejection ratio<br>$CMR = 20 \log (\Delta V_{ic}/\Delta V_{io})$<br>( $V_{ic} = -0.1\text{ V}$ to $V_{CC}+0.1\text{ V}$ ,<br>$V_{out} = V_{CC}/2$ , $R_L > 1\text{ M}\Omega$ ) | $T = 25\text{ °C}$                           | 47   | 66   |                    |                         |
|                          |  | $-40\text{ °C} < T < 125\text{ °C}$          | 45   |      |                    |                         |
| $A_{vd}$                 | Large signal voltage gain<br>( $V_{out} = 0.5\text{ V}$ to $(V_{CC} - 0.5\text{ V})$ ,<br>$R_L > 1\text{ M}\Omega$ )   | $T = 25\text{ °C}$                           | 85   |      |                    |                         |
|                          |  | $-40\text{ °C} < T < 125\text{ °C}$          | 83   |      |                    |                         |
| $V_{OH}$                 | High level output voltage<br>( $V_{OH} = V_{CC} - V_{out}$ )   | $T = 25\text{ °C}$                           |      |      | 70                 | mV                      |
|                          |  | $-40\text{ °C} < T < 125\text{ °C}$          |      |      | 100                |                         |
| $V_{OL}$                 | Low level output voltage   | $T = 25\text{ °C}$                           |      |      | 70                 |                         |
|                          |  | $-40\text{ °C} < T < 125\text{ °C}$          |      |      | 100                |                         |
| $I_{out}$                | $I_{sink}$ ( $V_{out} = V_{CC}$ )  | $T = 25\text{ °C}$                           | 4.3  | 5.3  |                    | mA                      |
|                          |  | $-40\text{ °C} < T < 125\text{ °C}$          | 2.5  |      |                    |                         |
|                          | $I_{source}$ ( $V_{out} = 0\text{ V}$ )  | $T = 25\text{ °C}$                           | 3.3  | 4.3  |                    |                         |
|                          |  | $-40\text{ °C} < T < 125\text{ °C}$          | 2.5  |      |                    |                         |
| $I_{CC}$                 | Supply current<br>(per channel, $V_{out} = V_{CC}/2$ ,<br>$R_L > 1\text{ M}\Omega$ )   | $T = 25\text{ °C}$                           |      | 220  | 300                | $\mu\text{A}$           |
|                          |  | $-40\text{ °C} < T < 125\text{ °C}$          |      |      | 350                |                         |

**Table 4. Electrical characteristics at  $V_{CC+} = +3.3$  V with  $V_{CC-} = 0$  V,  $V_{icm} = V_{CC}/2$ ,  $T_{amb} = 25$  °C, and  $R_L = 10$  k $\Omega$  connected to  $V_{CC}/2$  (unless otherwise specified) (continued)**

| Symbol                | Parameter                              | Conditions  | Min. | Typ.     | Max. | Unit                   |
|-----------------------|--|---|------|----------|------|------------------------|
| <b>AC performance</b> |  |   |      |          |      |                        |
| GBP                   | Gain bandwidth product                 | $R_L = 10$ k $\Omega$ , $C_L = 100$ pF  | 600  | 800      |      | kHz                    |
| $F_u$                 | Unity gain frequency                   |   |      | 690      |      |                        |
| $\Phi_m$              | Phase margin                           |   |      | 55       |      | Degree                 |
| $G_m$                 | Gain margin                            |   |      | 9        |      | dB                     |
| SR                    | Slew rate                              | $R_L = 10$ k $\Omega$ , $C_L = 100$ pF,<br>$V_{out} = 0.5$ V to $V_{CC} - 0.5$ V  |      | 1        |      | V/ $\mu$ s             |
| $\int e_n$            | Low-frequency peak-to-peak input noise | Bandwidth: $f = 0.1$ to $10$ Hz   |      | 16       |      | $\mu$ V <sub>pp</sub>  |
| $e_n$                 | Equivalent input noise voltage density | $f = 1$ kHz<br>$f = 10$ kHz   |      | 55<br>29 |      | $\frac{nV}{\sqrt{Hz}}$ |
| THD+N                 | Total harmonic distortion + noise      | Follower configuration,<br>$f_{in} = 1$ kHz,<br>$R_L = 100$ k $\Omega$ ,<br>$V_{icm} = (V_{CC} - 1.5$ V)/2,<br>BW = 22 kHz, $V_{out} = 1$ V <sub>pp</sub> |      | 0.004    |      | %                      |

1. See [Section 4.3: Input offset voltage drift over temperature on page 15](#).
2. Guaranteed by design.

**Table 5. Electrical characteristics at  $V_{CC+} = +5\text{ V}$  with  $V_{CC-} = 0\text{ V}$ ,  $V_{icm} = V_{CC}/2$ ,  $T_{amb} = 25\text{ }^\circ\text{C}$ , and  $R_L = 10\text{ k}\Omega$  connected to  $V_{CC}/2$  (unless otherwise specified)**

| Symbol                   | Parameter   | Conditions  | Min. | Typ. | Max.               | Unit                                    |
|--------------------------|---|---|------|------|--------------------|---|
| <b>DC performance</b>    |   |   |      |      |                    |   |
| $V_{io}$                 | Offset voltage  | TSX56xA, $T = 25\text{ }^\circ\text{C}$   |      |      | 600                | $\mu\text{V}$                           |
|                          |   | TSX56xA, $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$  |      |      | 1800               |   |
|                          |   | TSX56x, $T = 25\text{ }^\circ\text{C}$  |      |      | 1                  | mV                                      |
|                          |   | TSX56x, $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   |      |      | 2.2                |   |
| $\Delta V_{io}/\Delta T$ | Input offset voltage drift  | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}^{(1)}$   |      | 2    | 12                 | $\mu\text{V}/^\circ\text{C}$            |
| $\Delta V_{io}$          | Long-term input offset voltage drift  | $T = 25\text{ }^\circ\text{C}^{(2)}$  |      | 5    |                    | $\frac{\text{nV}}{\sqrt{\text{month}}}$ |
| $I_{io}$                 | Input offset current<br>( $V_{out} = V_{CC}/2$ )  | $T = 25\text{ }^\circ\text{C}$  |      | 1    | 100 <sup>(3)</sup> | pA                                      |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   |      | 1    | 200 <sup>(3)</sup> |   |
| $I_{ib}$                 | Input bias current<br>( $V_{out} = V_{CC}/2$ )  | $T = 25\text{ }^\circ\text{C}$  |      | 1    | 100 <sup>(3)</sup> |   |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   |      | 1    | 200 <sup>(3)</sup> |   |
| CMR1                     | Common mode rejection ratio<br>$\text{CMR} = 20 \log (\Delta V_{ic}/\Delta V_{io})$<br>( $V_{ic} = -0.1\text{ V}$ to $V_{CC} - 1.5\text{ V}$ ,<br>$V_{out} = V_{CC}/2$ , $R_L > 1\text{ M}\Omega$ ) | $T = 25\text{ }^\circ\text{C}$  | 66   | 84   |                    | dB                                      |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   | 63   |      |                    |   |
| CMR2                     | Common mode rejection ratio<br>$\text{CMR} = 20 \log (\Delta V_{ic}/\Delta V_{io})$<br>( $V_{ic} = -0.1\text{ V}$ to $V_{CC} + 0.1\text{ V}$ ,<br>$V_{out} = V_{CC}/2$ , $R_L > 1\text{ M}\Omega$ ) | $T = 25\text{ }^\circ\text{C}$  | 50   | 69   |                    |   |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   | 47   |      |                    |   |
| $A_{vd}$                 | Large signal voltage gain<br>( $V_{out} = 0.5\text{ V}$ to $(V_{CC} - 0.5\text{ V})$ ,<br>$R_L > 1\text{ M}\Omega$ )  | $T = 25\text{ }^\circ\text{C}$  | 85   |      |                    |   |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   | 83   |      |                    |   |
| $V_{OH}$                 | High level output voltage<br>( $V_{OH} = V_{CC} - V_{out}$ )  | $R_L = 10\text{ k}\Omega$ , $T = 25\text{ }^\circ\text{C}$<br>$R_L = 10\text{ k}\Omega$ , $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$ |      |      | 70<br>100          | mV                                      |
| $V_{OL}$                 | Low level output voltage  | $R_L = 10\text{ k}\Omega$ , $T = 25\text{ }^\circ\text{C}$<br>$R_L = 10\text{ k}\Omega$ , $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$ |      |      | 70<br>100          |   |
| $I_{out}$                | $I_{sink}$  | $V_{out} = V_{CC}$ , $T = 25\text{ }^\circ\text{C}$   | 11   | 14   |                    | mA                                      |
|                          |   | $V_{out} = V_{CC}$ , $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$  | 8    |      |                    |   |
|                          | $I_{source}$  | $V_{out} = 0\text{ V}$ , $T = 25\text{ }^\circ\text{C}$   | 9    | 12   |                    |   |
|                          |   | $V_{out} = 0\text{ V}$ , $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$  | 7    |      |                    |   |
| $I_{CC}$                 | Supply current<br>(per channel, $V_{out} = V_{CC}/2$ ,<br>$R_L > 1\text{ M}\Omega$ )  | $T = 25\text{ }^\circ\text{C}$  |      | 235  | 350                | $\mu\text{A}$                           |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   |      |      | 400                |   |

**Table 5. Electrical characteristics at  $V_{CC+} = +5\text{ V}$  with  $V_{CC-} = 0\text{ V}$ ,  $V_{icm} = V_{CC}/2$ ,  $T_{amb} = 25\text{ °C}$ , and  $R_L = 10\text{ k}\Omega$  connected to  $V_{CC}/2$  (unless otherwise specified) (continued)**

| Symbol                | Parameter                              | Conditions   | Min. | Typ.     | Max. | Unit                   |
|-----------------------|--|--|------|----------|------|------------------------|
| <b>AC performance</b> |  |  |      |          |      |                        |
| GBP                   | Gain bandwidth product                 | $R_L = 10\text{ k}\Omega$ , $C_L = 100\text{ pF}$  | 700  | 850      |      | kHz                    |
| $F_u$                 | Unity gain frequency                   |  |      | 730      |      |                        |
| $\Phi_m$              | Phase margin                           |  |      | 55       |      | Degree                 |
| $G_m$                 | Gain margin                            |  |      | 9        |      | dB                     |
| SR                    | Slew rate                              | $R_L = 10\text{ k}\Omega$ , $C_L = 100\text{ pF}$ ,<br>$V_{out} = 0.5\text{ V}$ to $V_{CC} - 0.5\text{ V}$   |      | 1.1      |      | V/ $\mu$ s             |
| $\int e_n$            | Low-frequency peak-to-peak input noise | Bandwidth: $f = 0.1$ to $10\text{ Hz}$   |      | 15       |      | $\mu$ V <sub>pp</sub>  |
| $e_n$                 | Equivalent input noise voltage density | $f = 1\text{ kHz}$<br>$f = 10\text{ kHz}$  |      | 55<br>29 |      | $\frac{nV}{\sqrt{Hz}}$ |
| THD+N                 | Total harmonic distortion + noise      | Follower configuration,<br>$f_{in} = 1\text{ kHz}$ ,<br>$R_L = 100\text{ k}\Omega$ , $V_{icm} = (V_{CC} - 1.5\text{ V})/2$ ,<br>$BW = 22\text{ kHz}$ , $V_{out} = 2\text{ V}_{pp}$ |      | 0.002    |      | %                      |

1. See [Section 4.3: Input offset voltage drift over temperature on page 15](#).
2. Typical value is based on the  $V_{io}$  drift observed after 1000h at 125 °C extrapolated to 25 °C using the Arrhenius law and assuming an activation energy of 0.7 eV. The operational amplifier is aged in follower mode configuration.
3. Guaranteed by design.



**Table 6. Electrical characteristics at  $V_{CC+} = +16\text{ V}$  with  $V_{CC-} = 0\text{ V}$ ,  $V_{icm} = V_{CC}/2$ ,  $T_{amb} = 25\text{ }^\circ\text{C}$ , and  $R_L = 10\text{ k}\Omega$  connected to  $V_{CC}/2$  (unless otherwise specified)**

| Symbol                   | Parameter   | Conditions  | Min. | Typ. | Max.        | Unit                                      |
|--------------------------|---|---|------|------|-------------|---|
| <b>DC performance</b>    |   |   |      |      |             |   |
| $V_{io}$                 | Offset voltage  | TSX56xA, $T = 25\text{ }^\circ\text{C}$   |      |      | 600         | $\mu\text{V}$                             |
|                          |   | TSX56xA, $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$  |      |      | 1800        |   |
|                          |   | TSX56x, $T = 25\text{ }^\circ\text{C}$  |      |      | 1           | mV  |
|                          |   | TSX56x, $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   |      |      | 2.2         |   |
| $\Delta V_{io}/\Delta T$ | Input offset voltage drift  | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}^{(1)}$   |      | 2    | 12          | $\mu\text{V}/^\circ\text{C}$              |
| $\Delta V_{io}$          | Long-term input offset voltage drift  | $T = 25\text{ }^\circ\text{C}^{(2)}$  |      | 1.6  |             | $\frac{\mu\text{V}}{\sqrt{\text{month}}}$ |
| $I_{io}$                 | Input offset current<br>( $V_{out} = V_{CC}/2$ )  | $T = 25\text{ }^\circ\text{C}$  |      | 1    | $100^{(3)}$ | pA  |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   |      | 1    | $200^{(3)}$ |   |
| $I_{ib}$                 | Input bias current<br>( $V_{out} = V_{CC}/2$ )  | $T = 25\text{ }^\circ\text{C}$  |      | 1    | $100^{(3)}$ |   |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   |      | 1    | $200^{(3)}$ |   |
| CMR1                     | Common mode rejection ratio<br>$\text{CMR} = 20 \log (\Delta V_{ic}/\Delta V_{io})$<br>( $V_{ic} = -0.1\text{ V}$ to $V_{CC} - 1.5\text{ V}$ ,<br>$V_{out} = V_{CC}/2$ , $R_L > 1\text{ M}\Omega$ ) | $T = 25\text{ }^\circ\text{C}$  | 76   | 95   |             | dB  |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   | 72   |      |             |   |
| CMR2                     | Common mode rejection ratio<br>$\text{CMR} = 20 \log (\Delta V_{ic}/\Delta V_{io})$<br>( $V_{ic} = -0.1\text{ V}$ to $V_{CC} + 0.1\text{ V}$ ,<br>$V_{out} = V_{CC}/2$ , $R_L > 1\text{ M}\Omega$ ) | $T = 25\text{ }^\circ\text{C}$  | 60   | 78   |             |   |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   | 56   |      |             |   |
| SVR                      | Common mode rejection ratio<br>$20 \log (\Delta V_{CC}/\Delta V_{io})$<br>( $V_{CC} = 3\text{ V}$ to $16\text{ V}$ ,<br>$V_{out} = V_{icm} = V_{CC}/2$ )  | $T = 25\text{ }^\circ\text{C}$  | 76   | 90   |             |   |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   | 72   |      |             |   |
| $A_{vd}$                 | Large signal voltage gain<br>( $V_{out} = 0.5\text{ V}$ to $(V_{CC} - 0.5\text{ V})$ ,<br>$R_L > 1\text{ M}\Omega$ )  | $T = 25\text{ }^\circ\text{C}$  | 85   |      |             |   |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   | 83   |      |             |   |
| $V_{OH}$                 | High level output voltage<br>( $V_{OH} = V_{CC} - V_{out}$ )  | $R_L = 10\text{ k}\Omega$ , $T = 25\text{ }^\circ\text{C}$<br>$R_L = 10\text{ k}\Omega$ , $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$ |      |      | 70<br>100   | mV  |
| $V_{OL}$                 | Low level output voltage  | $R_L = 10\text{ k}\Omega$ , $T = 25\text{ }^\circ\text{C}$<br>$R_L = 10\text{ k}\Omega$ , $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$ |      |      | 70<br>100   |   |
| $I_{out}$                | $I_{sink}$  | $V_{out} = V_{CC}$ , $T = 25\text{ }^\circ\text{C}$   | 40   | 92   |             | mA  |
|                          |   | $V_{out} = V_{CC}$ , $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$  | 35   |      |             |   |
|                          | $I_{source}$  | $V_{out} = 0\text{ V}$ , $T = 25\text{ }^\circ\text{C}$   | 30   | 90   |             |   |
|                          |   | $V_{out} = 0\text{ V}$ , $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$  | 25   |      |             |   |
| $I_{CC}$                 | Supply current<br>(per channel, $V_{out} = V_{CC}/2$ ,<br>$R_L > 1\text{ M}\Omega$ )  | $T = 25\text{ }^\circ\text{C}$  |      | 250  | 360         | $\mu\text{A}$                             |
|                          |   | $-40\text{ }^\circ\text{C} < T < 125\text{ }^\circ\text{C}$   |      |      | 400         |   |

**Table 6. Electrical characteristics at  $V_{CC+} = +16\text{ V}$  with  $V_{CC-} = 0\text{ V}$ ,  $V_{icm} = V_{CC}/2$ ,  $T_{amb} = 25\text{ }^\circ\text{C}$ , and  $R_L = 10\text{ k}\Omega$  connected to  $V_{CC}/2$  (unless otherwise specified) (continued)**

| Symbol                | Parameter                              | Conditions  | Min. | Typ.     | Max. | Unit                   |
|-----------------------|--|---|------|----------|------|------------------------|
| <b>AC performance</b> |  |   |      |          |      |                        |
| GBP                   | Gain bandwidth product                 | $R_L = 10\text{ k}\Omega$ , $C_L = 100\text{ pF}$   | 750  | 900      |      | kHz                    |
| $F_u$                 | Unity gain frequency                   |   |      | 750      |      |                        |
| $\Phi_m$              | Phase margin                           |   |      | 55       |      | Degree                 |
| $G_m$                 | Gain margin                            |   |      | 9        |      | dB                     |
| SR                    | Slew rate                              | $R_L = 10\text{ k}\Omega$ , $C_L = 100\text{ pF}$ ,<br>$V_{out} = 0.5\text{ V}$ to $V_{CC} - 0.5\text{ V}$  |      | 1.1      |      | V/ $\mu\text{s}$       |
| $\int e_n$            | Low-frequency peak-to-peak input noise | Bandwidth: $f = 0.1$ to $10\text{ Hz}$  |      | 15       |      | $\mu\text{V}_{pp}$     |
| $e_n$                 | Equivalent input noise voltage density | $f = 1\text{ kHz}$<br>$f = 10\text{ kHz}$   |      | 48<br>27 |      | $\frac{nV}{\sqrt{Hz}}$ |
| THD+N                 | Total harmonic distortion + noise      | Follower configuration, $f_{in} = 1\text{ kHz}$ ,<br>$R_L = 100\text{ k}\Omega$ , $V_{icm} = (V_{CC} - 1.5\text{ V})/2$ ,<br>BW = $22\text{ kHz}$ , $V_{out} = 5\text{ V}_{pp}$ |      | 0.0005   |      | %                      |

1. See [Section 4.3: Input offset voltage drift over temperature on page 15](#).
2. Typical value is based on the  $V_{io}$  drift observed after 1000h at  $125\text{ }^\circ\text{C}$  extrapolated to  $25\text{ }^\circ\text{C}$  using the Arrhenius law and assuming an activation energy of  $0.7\text{ eV}$ . The operational amplifier is aged in follower mode configuration.
3. Guaranteed by design.

Figure 2. Supply current vs. supply voltage at  $V_{icm} = V_{CC}/2$

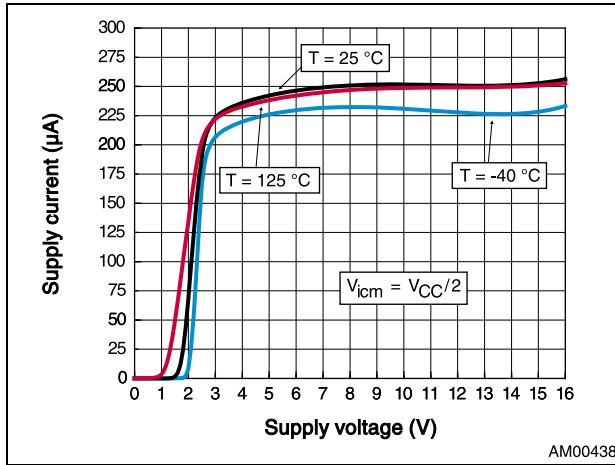


Figure 3. Input offset voltage distribution at  $V_{CC} = 16 V$  and  $V_{icm} = 8 V$

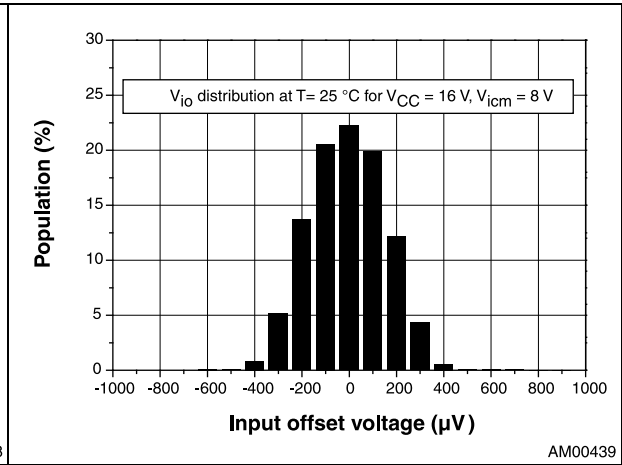


Figure 4. Input offset voltage temperature coefficient distribution at  $V_{CC} = 16 V$ ,  $V_{icm} = 8 V$

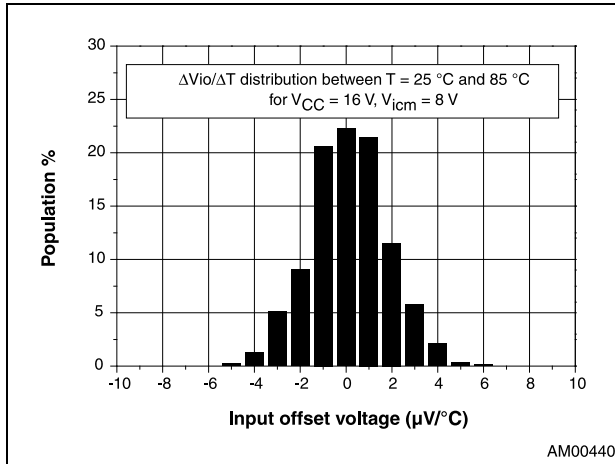


Figure 5. Input offset voltage vs. input common mode voltage at  $V_{CC} = 12 V$

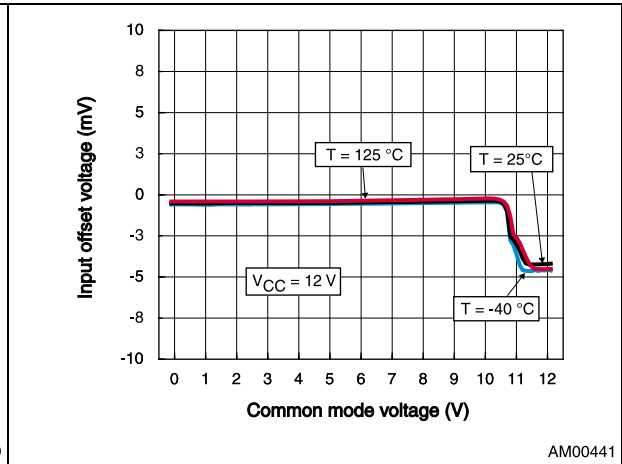


Figure 6. Input offset voltage vs. temperature at  $V_{CC} = 16 V$

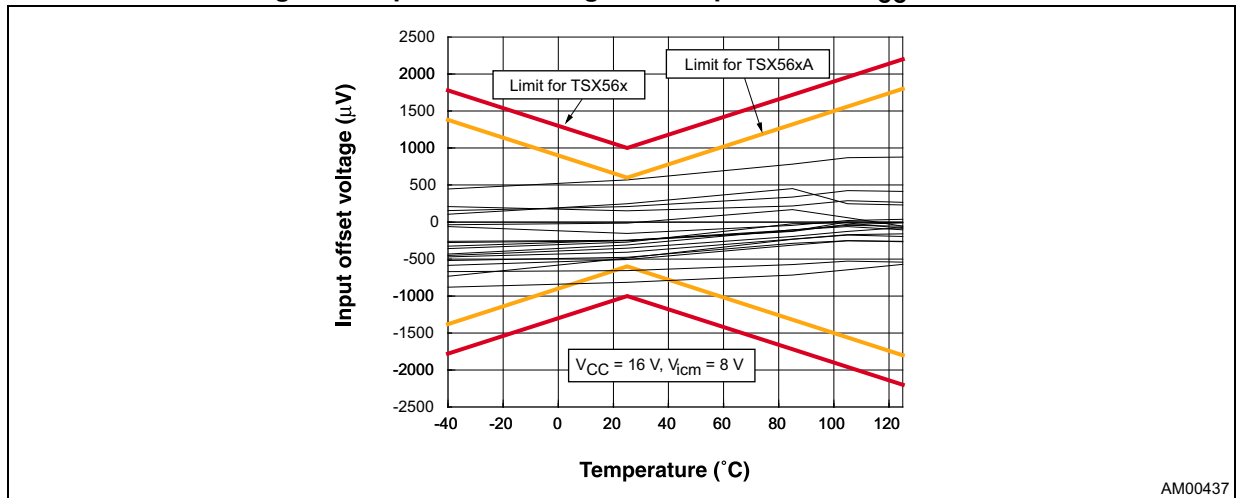


Figure 7. Output current vs. output voltage at  $V_{CC} = 3.3\text{ V}$

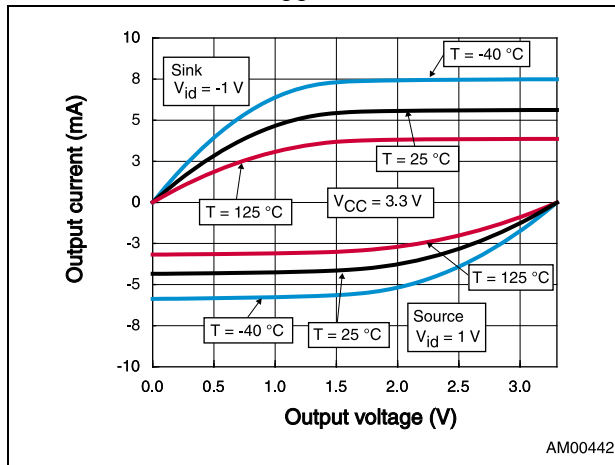


Figure 8. Output current vs. output voltage at  $V_{CC} = 5\text{ V}$

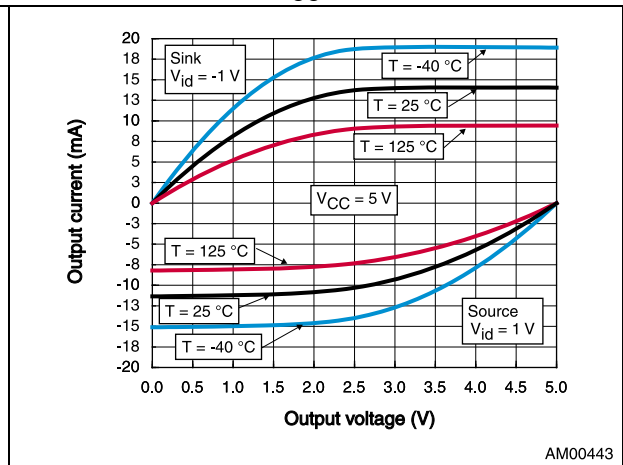


Figure 9. Output current vs. output voltage at  $V_{CC} = 16\text{ V}$

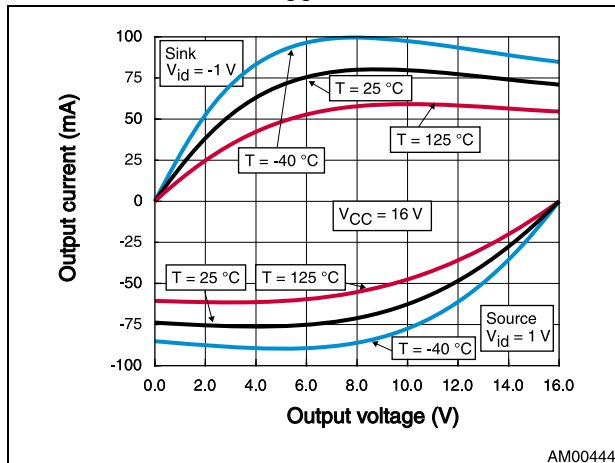


Figure 10. Bode diagram at  $V_{CC} = 3.3\text{ V}$

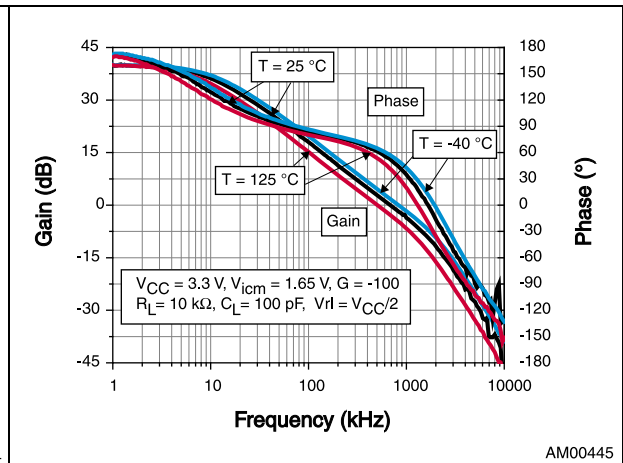


Figure 11. Bode diagram at  $V_{CC} = 5\text{ V}$

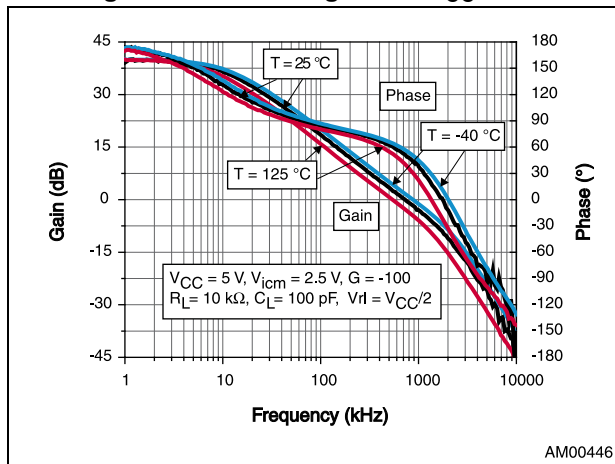


Figure 12. Bode diagram at  $V_{CC} = 16\text{ V}$

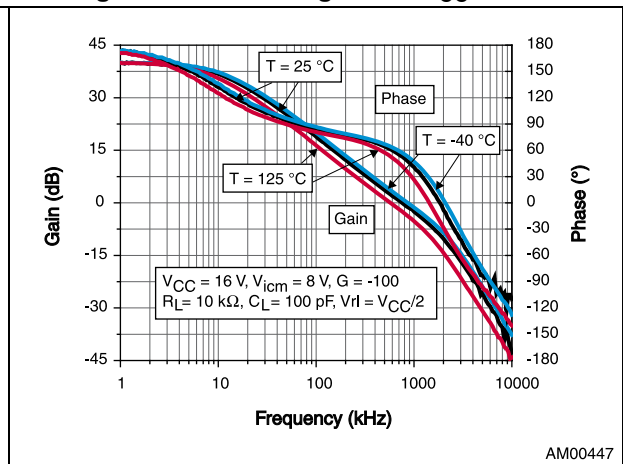


Figure 13. Phase margin vs. capacitive load at  $V_{CC} = 12\text{ V}$

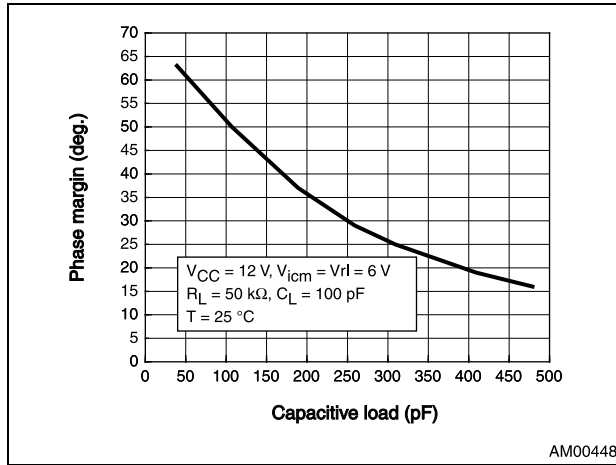


Figure 14. GBP vs. input common mode voltage at  $V_{CC} = 12\text{ V}$

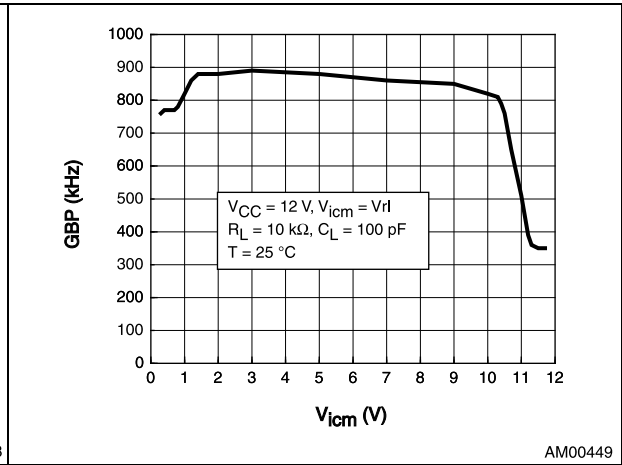


Figure 15.  $A_{vd}$  vs. input common mode voltage at  $V_{CC} = 12\text{ V}$

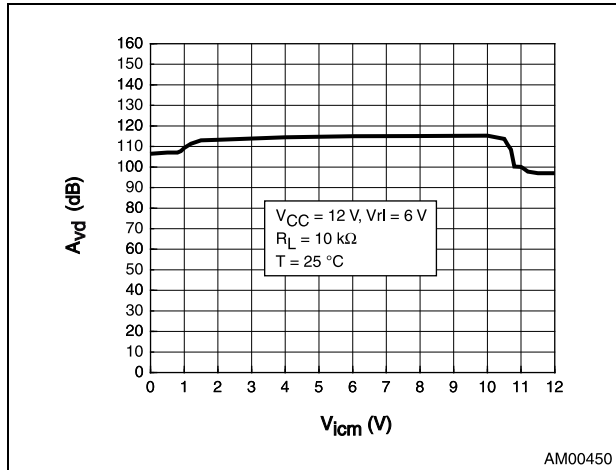


Figure 16. Slew rate vs. supply voltage

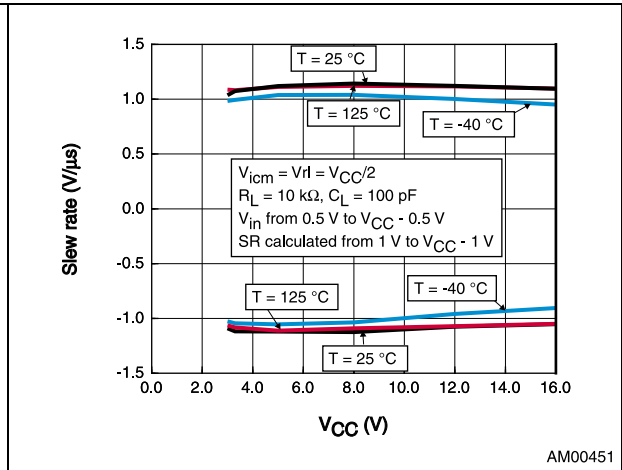


Figure 17. Noise vs. frequency at  $V_{CC} = 3.3\text{ V}$

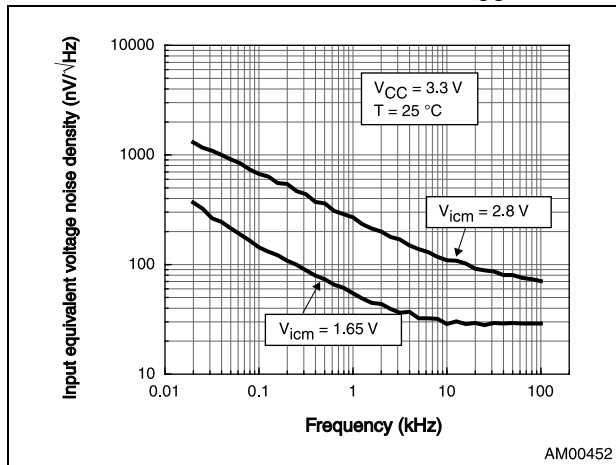


Figure 18. Noise vs. frequency at  $V_{CC} = 5\text{ V}$

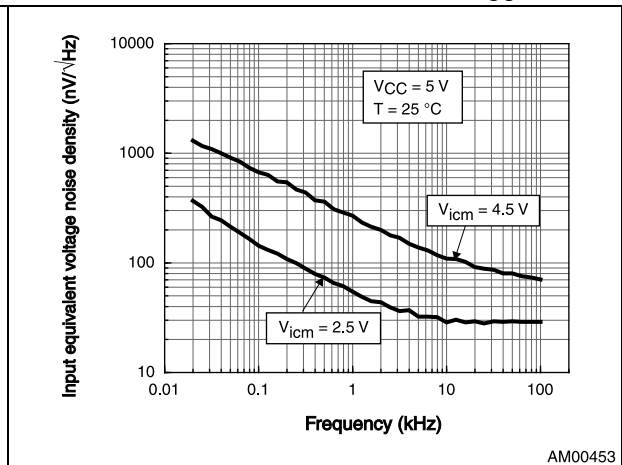


Figure 19. Noise vs. frequency at  $V_{CC} = 16\text{ V}$

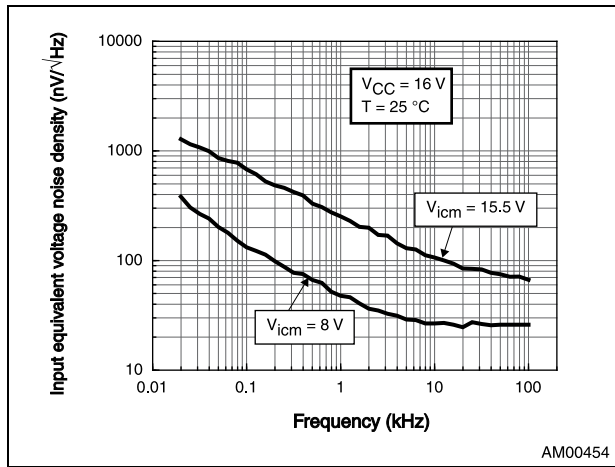


Figure 20. Distortion + noise vs. output voltage amplitude

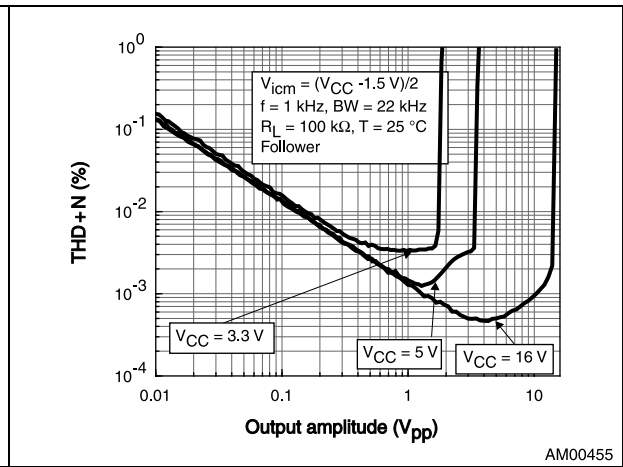


Figure 21. Distortion + noise vs. amplitude at  $V_{icsm} = V_{CC}/2$  and  $V_{CC} = 12\text{ V}$

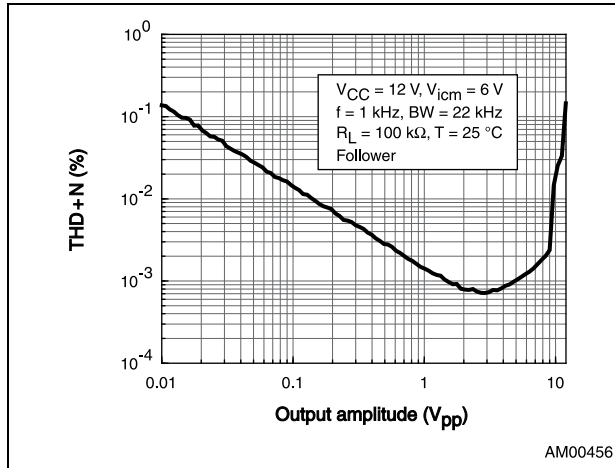
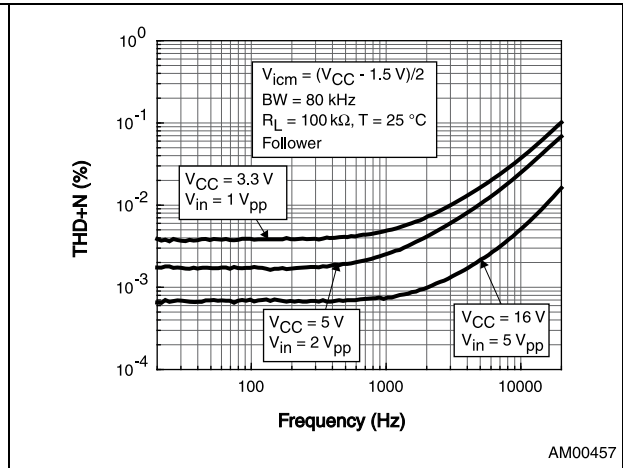


Figure 22. Distortion + noise vs. frequency



## 4 Application information

### 4.1 Operating voltages

The amplifiers of the TSX56x and TSX56xA series can operate from 3 V to 16 V. Their parameters are fully specified at 3.3 V, 5 V and 16 V power supplies. However, the parameters are very stable in the full  $V_{CC}$  range. Additionally, the main specifications are guaranteed in extended temperature ranges from -40 to +125 °C.

### 4.2 Rail-to-rail input

The TSX56x and TSX56xA devices are built with two complementary PMOS and NMOS input differential pairs. The devices have a rail-to-rail input, and the input common mode range is extended from  $V_{CC-} - 0.1$  V to  $V_{CC+} + 0.1$  V.

However, the performance of these devices is clearly optimized for the PMOS differential pairs (which means from  $V_{CC-} - 0.1$  V to  $V_{CC+} - 1.5$  V).

Beyond  $V_{CC+} - 1.5$  V, the operational amplifiers are still functional but with degraded performance, as can be observed in the electrical characteristics section of this datasheet (mainly  $V_{io}$  and GBP). These performances are suitable for a number of applications needing to be rail-to-rail.

The devices are designed to prevent phase reversal.

### 4.3 Input offset voltage drift over temperature

The maximum input voltage drift over the temperature variation is defined as the offset variation related to the offset value measured at 25 °C. The operational amplifier is one of the main circuits of the signal conditioning chain, and the amplifier input offset is a major contributor to the chain accuracy. The signal chain accuracy at 25 °C can be compensated during production at application level. The maximum input voltage drift over temperature enables the system designer to anticipate the effects of temperature variations.

The maximum input voltage drift over temperature is computed in [Equation 1](#).

#### Equation 1

$$\frac{\Delta V_{io}}{\Delta T} = \max \left| \frac{V_{io}(T) - V_{io}(25^\circ \text{C})}{T - 25^\circ \text{C}} \right|$$

with  $T = -40$  °C and  $125$  °C.

The datasheet maximum value is guaranteed by measurement on a representative sample size ensuring a  $C_{pk}$  (process capability index) greater than 2.

## 4.4 Long term input offset voltage drift

To evaluate product reliability, two types of stress acceleration are used:

- Voltage acceleration, by changing the applied voltage
- Temperature acceleration, by changing the die temperature (below the maximum junction temperature allowed by the technology) with the ambient temperature.

The voltage acceleration has been defined based on JEDEC results, and is defined using [Equation 2](#).

### Equation 2

$$A_{FV} = e^{\beta \cdot (V_S - V_U)}$$

Where:

$A_{FV}$  is the voltage acceleration factor

$\beta$  is the voltage acceleration constant in  $1/V$ , constant technology parameter ( $\beta = 1$ )

$V_S$  is the stress voltage used for the accelerated test

$V_U$  is the voltage used for the application

The temperature acceleration is driven by the Arrhenius model, and is defined in [Equation 3](#).

### Equation 3

$$A_{FT} = e^{\frac{E_a}{k} \cdot \left( \frac{1}{T_U} - \frac{1}{T_S} \right)}$$

Where:

$A_{FT}$  is the temperature acceleration factor

$E_a$  is the activation energy of the technology based on the failure rate

$k$  is the Boltzmann constant ( $8.6173 \times 10^{-5} \text{ eV.K}^{-1}$ )

$T_U$  is the temperature of the die when  $V_U$  is used (K)

$T_S$  is the temperature of the die under temperature stress (K)

The final acceleration factor,  $A_F$ , is the multiplication of the voltage acceleration factor and the temperature acceleration factor ([Equation 4](#)).

### Equation 4

$$A_F = A_{FT} \times A_{FV}$$

$A_F$  is calculated using the temperature and voltage defined in the mission profile of the product. The  $A_F$  value can then be used in [Equation 5](#) to calculate the number of months of use equivalent to 1000 hours of reliable stress duration.



**Equation 5**

$$\text{Months} = A_F \times 1000 \text{ h} \times 12 \text{ months} / (24 \text{ h} \times 365.25 \text{ days})$$

To evaluate the op-amp reliability, a follower stress condition is used where  $V_{CC}$  is defined as a function of the maximum operating voltage and the absolute maximum rating (as recommended by JEDEC rules).

The  $V_{io}$  drift (in  $\mu\text{V}$ ) of the product after 1000 h of stress is tracked with parameters at different measurement conditions (see [Equation 6](#)).

**Equation 6**

$$V_{CC} = \max V_{op} \text{ with } V_{icm} = V_{CC} / 2$$

The long term drift parameter ( $\Delta V_{io}$ ), estimating the reliability performance of the product, is obtained using the ratio of the  $V_{io}$  (input offset voltage value) drift over the square root of the calculated number of months ([Equation 7](#)).

**Equation 7**

$$\Delta V_{io} = \frac{V_{io} \text{ drift}}{\sqrt{(\text{months})}}$$

where  $V_{io}$  drift is the measured drift value in the specified test conditions after 1000 h stress duration.

**4.5 PCB layouts**

For correct operation, it is advised to add 10 nF decoupling capacitors as close as possible to the power supply pins.

**4.6 Macromodel**

Accurate macromodels of the TSX56x, TSX56xA devices are available on the STMicroelectronics' website at [www.st.com](http://www.st.com). These models are a trade-off between accuracy and complexity (that is, time simulation) of the TSX56x and TSX56xA operational amplifiers. They emulate the nominal performance of a typical device within the specified operating conditions mentioned in the datasheet. They also help to validate a design approach and to select the right operational amplifier, *but they do not replace on-board measurements*.

## 5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 5.1 SOT23-5 package information

Figure 23. SOT23-5 package mechanical drawing

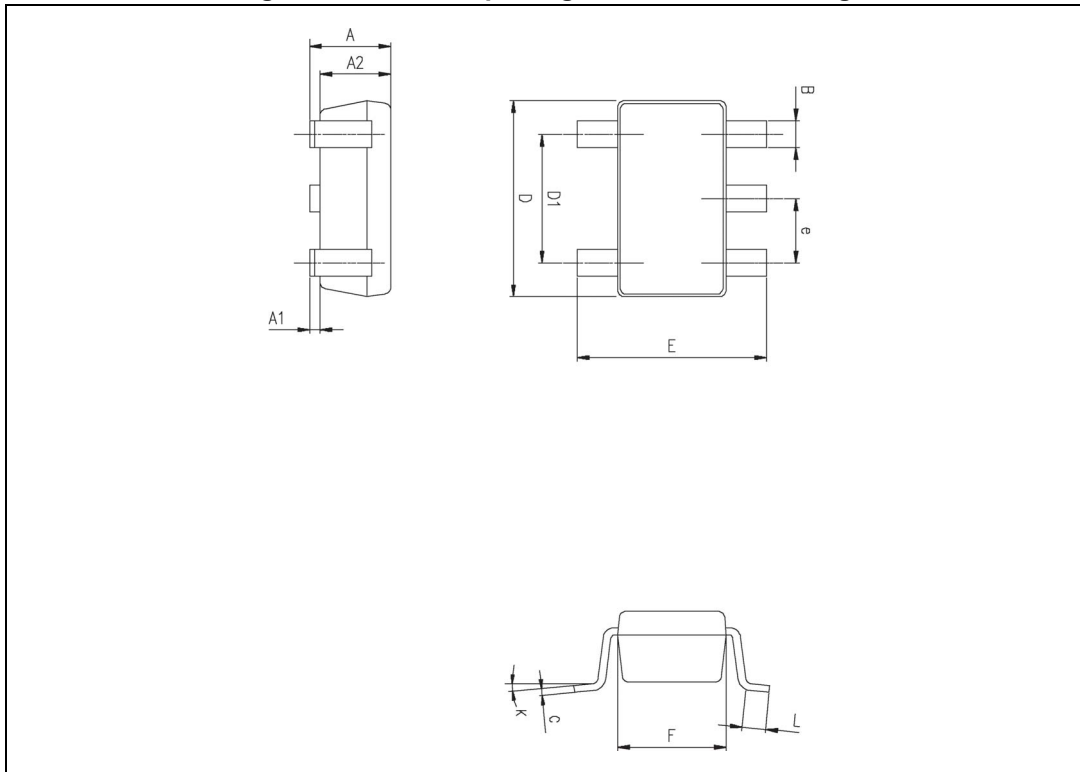


Table 7. SOT23-5 package mechanical data

| Ref. | Dimensions  |      |      |        |       |       |
|------|-------------|------|------|--------|-------|-------|
|      | Millimeters |      |      | Inches |       |       |
|      | Min.        | Typ. | Max. | Min.   | Typ.  | Max.  |
| A    | 0.90        | 1.20 | 1.45 | 0.035  | 0.047 | 0.057 |
| A1   |             |      | 0.15 |        |       | 0.006 |
| A2   | 0.90        | 1.05 | 1.30 | 0.035  | 0.041 | 0.051 |
| B    | 0.35        | 0.40 | 0.50 | 0.013  | 0.015 | 0.019 |
| C    | 0.09        | 0.15 | 0.20 | 0.003  | 0.006 | 0.008 |
| D    | 2.80        | 2.90 | 3.00 | 0.110  | 0.114 | 0.118 |
| D1   |             | 1.90 |      |        | 0.075 |       |
| e    |             | 0.95 |      |        | 0.037 |       |
| E    | 2.60        | 2.80 | 3.00 | 0.102  | 0.110 | 0.118 |
| F    | 1.50        | 1.60 | 1.75 | 0.059  | 0.063 | 0.069 |
| L    | 0.10        | 0.35 | 0.60 | 0.004  | 0.013 | 0.023 |
| K    | 0 °         |      | 10 ° | 0 °    |       | 10 °  |

## 5.2 DFN8 2x2 package information

Figure 24. DFN8 2x2 package mechanical drawing

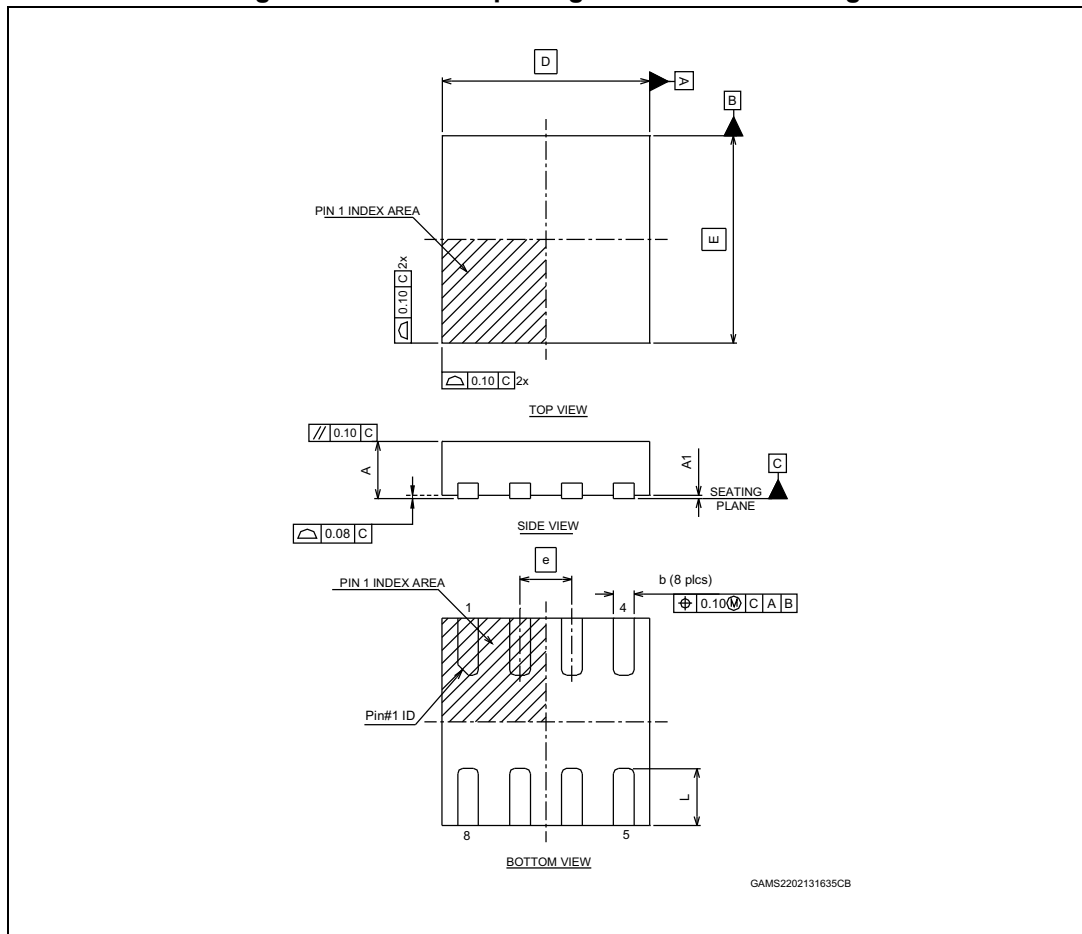


Table 8. DFN8 2x2 package mechanical data

| Ref. | Dimensions  |      |      |        |       |       |
|------|-------------|------|------|--------|-------|-------|
|      | Millimeters |      |      | Inches |       |       |
|      | Min.        | Typ. | Max. | Min.   | Typ.  | Max.  |
| A    | 0.70        | 0.75 | 0.80 | 0.028  | 0.030 | 0.031 |
| A1   | 0.00        | 0.02 | 0.05 | 0.000  | 0.001 | 0.002 |
| b    | 0.15        | 0.20 | 0.25 | 0.006  | 0.008 | 0.010 |
| D    |             | 2.00 |      |        | 0.079 |       |
| E    |             | 2.00 |      |        | 0.079 |       |
| e    |             | 0.50 |      |        | 0.020 |       |
| L    | 0.045       | 0.55 | 0.65 | 0.018  | 0.022 | 0.026 |
| N    | 8           |      |      | 8      |       |       |

### 5.3 MiniSO8 package information

Figure 25. MiniSO8 package mechanical drawing

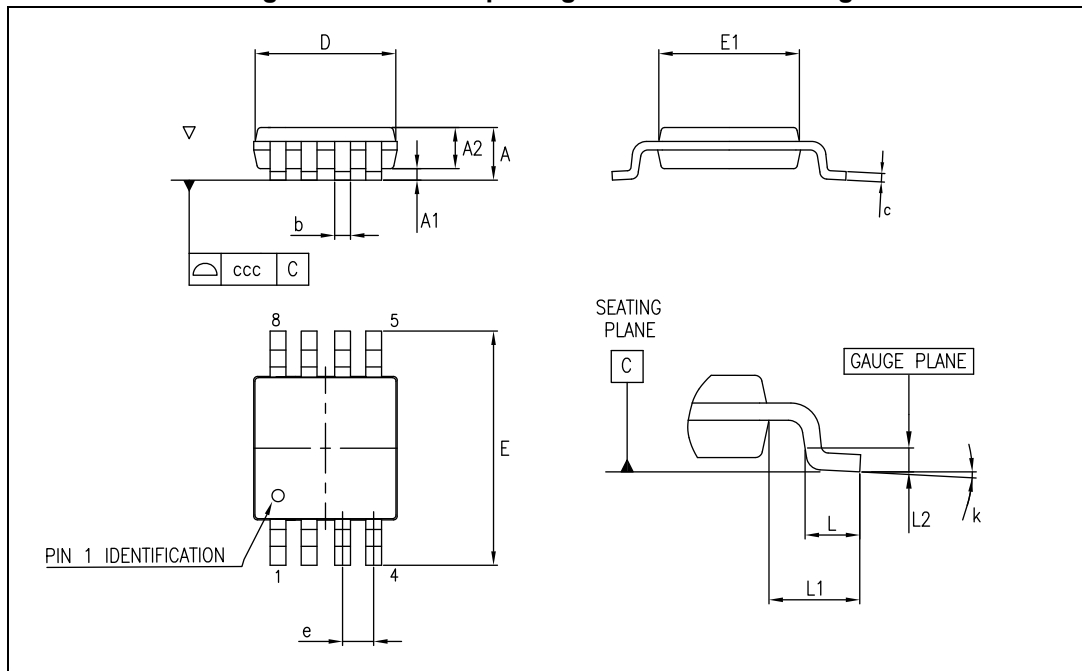


Table 9. MiniSO8 package mechanical data

| Symbol | Dimensions  |      |      |        |       |       |
|--------|-------------|------|------|--------|-------|-------|
|        | Millimeters |      |      | Inches |       |       |
|        | Min.        | Typ. | Max. | Min.   | Typ.  | Max.  |
| A      |             |      | 1.10 |        |       | 0.043 |
| A1     | 0           |      | 0.15 | 0      |       | 0.006 |
| A2     | 0.75        | 0.85 | 0.95 | 0.030  | 0.033 | 0.037 |
| b      | 0.22        |      | 0.40 | 0.009  |       | 0.016 |
| c      | 0.08        |      | 0.23 | 0.003  |       | 0.009 |
| D      | 2.80        | 3.00 | 3.20 | 0.11   | 0.118 | 0.126 |
| E      | 4.65        | 4.90 | 5.15 | 0.183  | 0.193 | 0.203 |
| E1     | 2.80        | 3.00 | 3.10 | 0.11   | 0.118 | 0.122 |
| e      |             | 0.65 |      |        | 0.026 |       |
| L      | 0.40        | 0.60 | 0.80 | 0.016  | 0.024 | 0.031 |
| L1     |             | 0.95 |      |        | 0.037 |       |
| L2     |             | 0.25 |      |        | 0.010 |       |
| k      | 0°          |      | 8°   | 0°     |       | 8°    |
| ccc    |             |      | 0.10 |        |       | 0.004 |

### 5.4 SO8 package information

Figure 26. SO8 package mechanical drawing

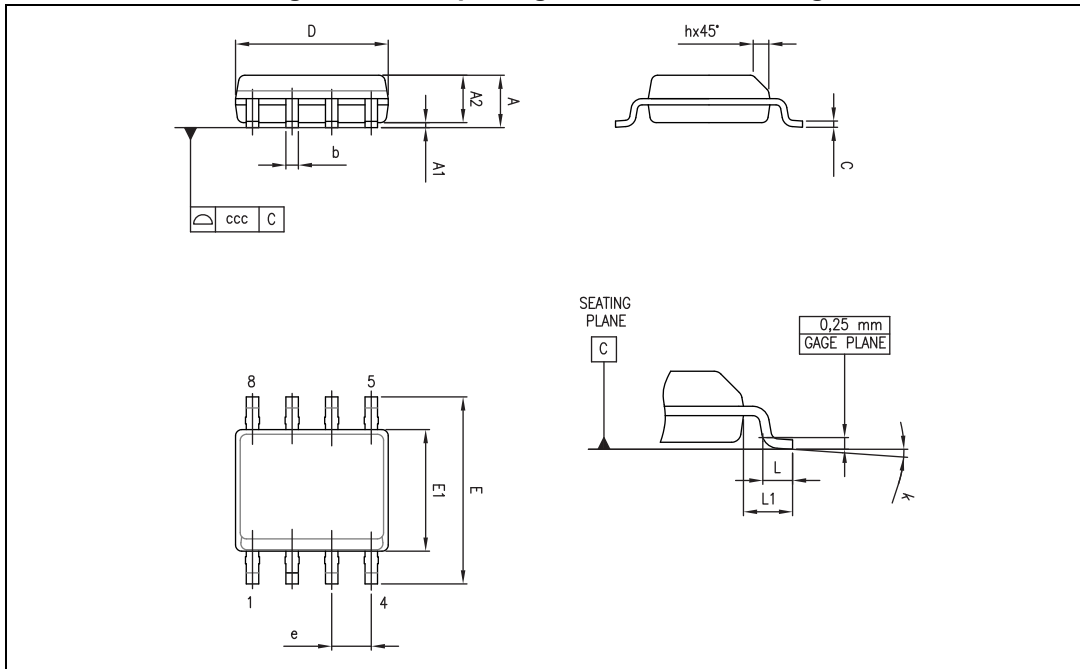


Table 10. SO8 package mechanical data

| Ref. | Dimensions  |      |      |        |       |       |
|------|-------------|------|------|--------|-------|-------|
|      | Millimeters |      |      | Inches |       |       |
|      | Min.        | Typ. | Max. | Min.   | Typ.  | Max.  |
| A    |             |      | 1.75 |        |       | 0.069 |
| A1   | 0.10        |      | 0.25 | 0.004  |       | 0.010 |
| A2   | 1.25        |      |      | 0.049  |       |       |
| b    | 0.28        |      | 0.48 | 0.011  |       | 0.019 |
| c    | 0.17        |      | 0.23 | 0.007  |       | 0.010 |
| D    | 4.80        | 4.90 | 5.00 | 0.189  | 0.193 | 0.197 |
| E    | 5.80        | 6.00 | 6.20 | 0.228  | 0.236 | 0.244 |
| E1   | 3.80        | 3.90 | 4.00 | 0.150  | 0.154 | 0.157 |
| e    |             | 1.27 |      |        | 0.050 |       |
| h    | 0.25        |      | 0.50 | 0.010  |       | 0.020 |
| L    | 0.40        |      | 1.27 | 0.016  |       | 0.050 |
| L1   |             | 1.04 |      |        | 0.040 |       |
| k    | 0           |      | 8 °  | 1 °    |       | 8 °   |
| ccc  |             |      | 0.10 |        |       | 0.004 |

### 5.5 QFN16 3x3 package information

Figure 27. QFN16 3x3 package mechanical drawing

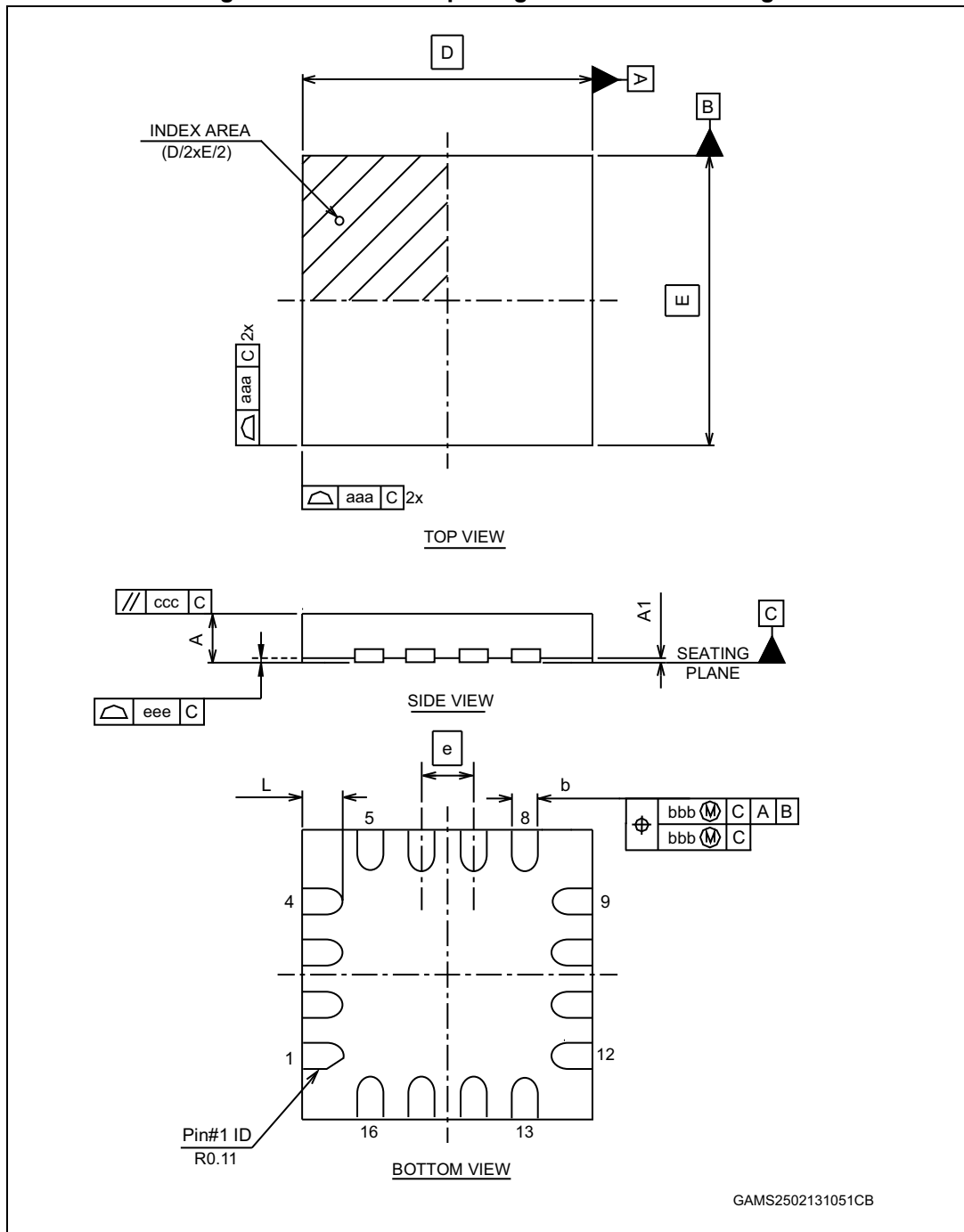


Table 11. QFN16 3x3 package mechanical data

| Ref. | Dimensions  |      |      |        |       |       |
|------|-------------|------|------|--------|-------|-------|
|      | Millimeters |      |      | Inches |       |       |
|      | Min.        | Typ. | Max. | Min.   | Typ.  | Max.  |
| A    | 0.50        |      | 0.65 | 0.020  |       | 0.026 |
| A1   | 0           |      | 0.05 | 0      |       | 0.002 |
| b    | 0.18        | 0.25 | 0.30 | 0.007  | 0.010 | 0.012 |
| D    |             | 3.00 |      |        | 0.118 |       |
| E    |             | 3.00 |      |        | 0.118 |       |
| e    |             | 0.50 |      |        | 0.020 |       |
| L    | 0.30        |      | 0.50 | 0.012  |       | 0.020 |
| aaa  |             |      | 0.15 |        |       | 0.006 |
| bbb  |             |      | 0.10 |        |       | 0.004 |
| ccc  |             |      | 0.10 |        |       | 0.004 |
| ddd  |             |      | 0.05 |        |       | 0.002 |
| eee  |             |      | 0.08 |        |       | 0.003 |



### 5.6 TSSOP14 package information

Figure 28. TSSOP14 package mechanical drawing

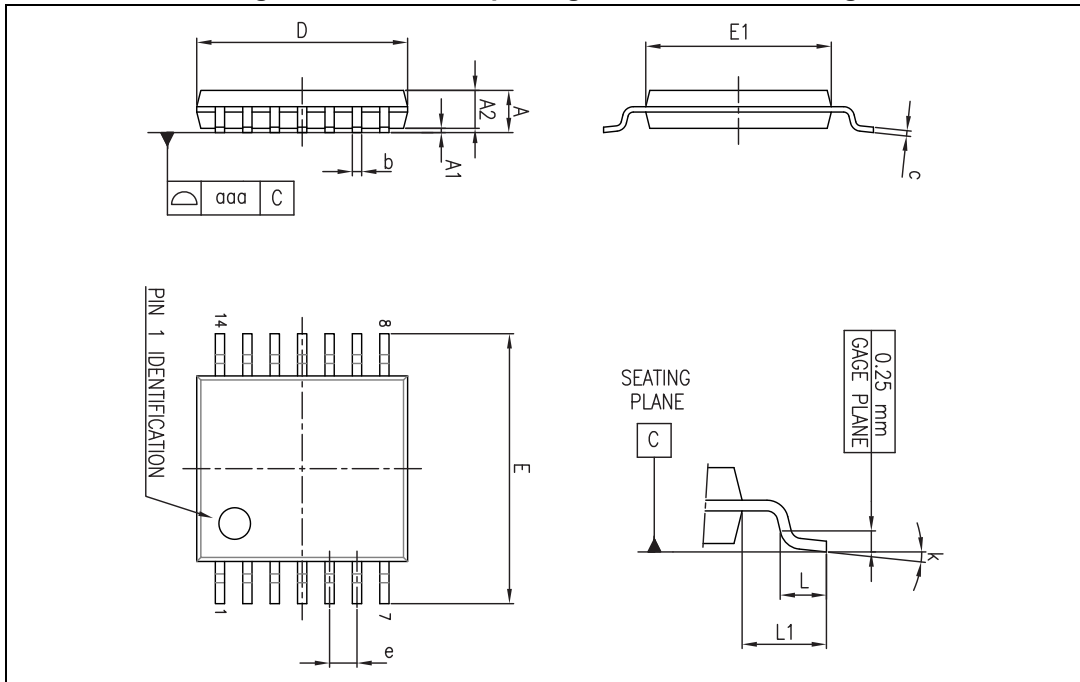


Table 12. TSSOP14 package mechanical data

| Symbol     | Dimensions  |      |      |        |            |        |
|------------|-------------|------|------|--------|------------|--------|
|            | Millimeters |      |      | Inches |            |        |
|            | Min.        | Typ. | Max. | Min.   | Typ.       | Max.   |
| <b>A</b>   |             |      | 1.20 |        |            | 0.047  |
| <b>A1</b>  | 0.05        |      | 0.15 | 0.002  | 0.004      | 0.006  |
| <b>A2</b>  | 0.80        | 1.00 | 1.05 | 0.031  | 0.039      | 0.041  |
| <b>b</b>   | 0.19        |      | 0.30 | 0.007  |            | 0.012  |
| <b>c</b>   | 0.09        |      | 0.20 | 0.004  |            | 0.0089 |
| <b>D</b>   | 4.90        | 5.00 | 5.10 | 0.193  | 0.197      | 0.201  |
| <b>E</b>   | 6.20        | 6.40 | 6.60 | 0.244  | 0.252      | 0.260  |
| <b>E1</b>  | 4.30        | 4.40 | 4.50 | 0.169  | 0.173      | 0.176  |
| <b>e</b>   |             | 0.65 |      |        | 0.0256 BSC |        |
| <b>L</b>   | 0.45        | 0.60 | 0.75 |        |            |        |
| <b>L1</b>  |             | 1.00 |      |        |            |        |
| <b>k</b>   | 0°          |      | 8°   | 0°     |            | 8°     |
| <b>aaa</b> |             |      | 0.10 | 0.018  | 0.024      | 0.030  |

## 6 Ordering information

Table 13. Order codes

| Order code                 | Temperature range                 | Channel number | Package     | Packaging     | Marking  |
|----------------------------|-----------------------------------|----------------|-------------|---------------|----------|
| TSX561ILT                  | -40 to 125 °C                     | 1              | SOT23-5     | Tape and reel | K23      |
| TSX562IQ2T                 |                                   | 2              | DFN8 2 x 2  |               |          |
| TSX562IST                  |                                   |                | MiniSO8     |               |          |
| TSX562IDT                  |                                   |                | SO8         |               | TSX562I  |
| TSX564IQ4T                 |                                   | 4              | QFN16 3 x 3 |               | K23      |
| TSX564IPT                  |                                   |                | TSSOP14     |               | TSX564I  |
| TSX561IYLT <sup>(1)</sup>  | -40 to 125 °C<br>automotive grade | 1              | SOT23-5     |               | K116     |
| TSX562IYST <sup>(1)</sup>  |                                   | 2              | MiniSO8     |               |          |
| TSX562IYDT <sup>(2)</sup>  |                                   |                | SO8         |               | TSX562Y  |
| TSX564IYPT <sup>(1)</sup>  |                                   | 4              | TSSOP14     |               | TSX564IY |
| TSX561AILT                 | -40 to 125 °C                     | 1              | SOT23-5     |               | K117     |
| TSX562AIST                 |                                   | 2              | MiniSO8     |               |          |
| TSX562AIDT                 |                                   |                | SO8         | TSX562AI      |          |
| TSX564AIPT                 |                                   | 4              | TSSOP14     | TSX564AI      |          |
| TSX561AIYLT <sup>(1)</sup> | -40 to 125 °C<br>automotive grade | 1              | SOT23-5     | K118          |          |
| TSX562AIYST <sup>(1)</sup> |                                   | 2              | MiniSO8     |               |          |
| TSX562AIYDT <sup>(2)</sup> |                                   |                | SO8         | TSX562AY      |          |
| TSX564AIYPT <sup>(1)</sup> |                                   | 4              | TSSOP14     | TSX564AIY     |          |

1. Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q 002 or equivalent.
2. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q 002 or equivalent are ongoing.

## 7 Revision history

**Table 14. Document revision history**

| Date        | Revision | Changes   |
|-------------|----------|---|
| 06-Jun-2012 | 1        | Initial release.  |
| 18-Sep-2012 | 2        | <p>Added TSX562, TSX564, TSX562A, and TSX564A devices.</p> <p>Updated <a href="#">Features</a>, <a href="#">Description</a>, <a href="#">Figure 1</a>, <a href="#">Table 1</a> (added DFN8, MiniSO8, QFN16, and TSSOP14 package).</p> <p>Updated <a href="#">Table 1</a> (updated ESD MM values).</p> <p>Updated <a href="#">Table 4</a> and <a href="#">Table 5</a> (added footnotes), <a href="#">Section 5</a> (added <a href="#">Figure 24</a> to <a href="#">Figure 28</a> and <a href="#">Table 8</a> to <a href="#">Table 12</a>), <a href="#">Table 13</a> (added dual and quad devices).</p> <p>Minor corrections throughout document.</p> |
| 23-May-2013 | 3        | <p>Replaced the silhouette, pinout, package diagram, and mechanical data of the DFN8 2x2 and QFN16 3x3 packages.</p> <p>Added <a href="#">Benefits</a> and <a href="#">Related products</a>.</p> <p><a href="#">Table 1</a>: updated <math>R_{thja}</math> values and added <math>R_{thjc}</math> values for DFN8 2x2 and QFN16 3x3.</p> <p>Updated <a href="#">Section 4.3</a>, <a href="#">Section 4.4</a>, and <a href="#">Section 4.6</a></p> <p>Replaced <a href="#">Figure 23: SOT23-5 package mechanical drawing</a> and <a href="#">Table 7: SOT23-5 package mechanical data</a>.</p>   |
| 09-Aug-2013 | 4        | <p>Added SO8 package for dual version TSX562 and TSX562A.</p> <p><a href="#">Table 2</a>: updated for SO8 package</p> <p><a href="#">Table 13</a>: added order codes TSX562IDT, TSX562IYDT, TSX562AIDT, TSX562AIYDT; updated automotive grade status.</p>   |

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